

SI3445DV-T1-GE3-VB Datasheet P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
- 60	0.075 at V _{GS} = - 10 V		5.1 nC			
- 60	0.085 at V _{GS} = - 4.5 V	- 5.5	5.1110			

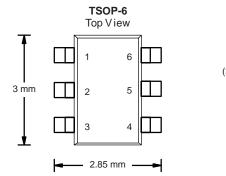
FEATURES

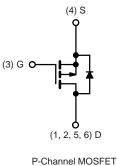
- Halogen-free According to IEC 61249-2-21 Available
- Trench Power MOSFET

APPLICATIONS

· Load Switch







ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted Symbol Parameter Limit Unit Drain-Source Voltage V_{DS} - 60 V ± 20 Gate-Source Voltage V_{GS} T_C = 25 °C - 6.5 T_C = 70 °C - 5.2 Continuous Drain Current (T_J = 150 °C) I_D T_A = 25 °C <u>- 6 .1^{b, c}</u> T_A = 70 °C А - 5 .3b, c Pulsed Drain Current I_{DM} - 19.5 T_C = 25 °C - 2.5 Continuous Source-Drain Diode Current I_S - 1.67^{b, c} T_A = 25 °C T_C = 25 °C 3.0 T_C = 70 °C 2.0 Maximum Power Dissipation P_D W T_A = 25 °C 2.0^{b, c} T_A = 70 °C 1.3^{b, c} T_J, T_{stg} °C **Operating Junction and Storage Temperature Range** - 55 to 150

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	$t \le 5 s$	R _{thJA}	55	62.5	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	34	41	0/11	

Notes:

a. Based on $T_C = 25 \text{ °C}$. b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under Steady State conditions is 110 °C/W.

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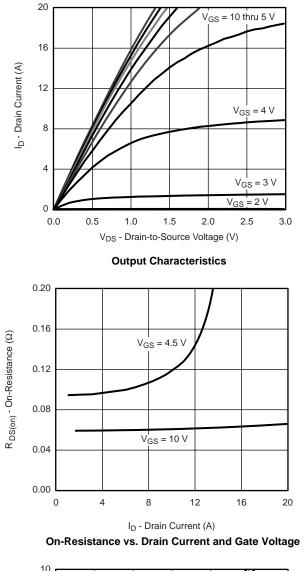
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static					•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA - 6				V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 250		- 31		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μΑ		4.5		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.0		- 3.0	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
		V _{DS} = - 48 V, V _{GS} = 0 V			- 1	μA
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = -48 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			- 10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	- 10			Α
		V _{GS} = - 10 V, I _D = - 2.1 A		0.075		Ω
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 2.1 A		0.085		
Forward Transconductance ^a				8		S
Dynamic ^b					1	
Input Capacitance	C _{iss}			1000		
Output Capacitance	C _{oss}	V_{DS} = - 15 V, V_{GS} = 0 V, f = 1 MHz		80		pF
Reverse Transfer Capacitance	C _{rss}			63		
Total Gate Charge	Qg	V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 2.1 A		10	15	nC
				5.1	8	
Gate-Source Charge	Q _{gs}	V_{DS} = - 15 V, V_{GS} = - 4.5 V, I_{D} = - 2.1 A		1.8		
Gate-Drain Charge	Q _{gd}			2.5		
Gate Resistance	Rg	f = 1 MHz		7		Ω
Turn-On Delay Time	t _{d(on)}			40	60	- ns
Rise Time	t _r	V_{DD} = - 15 V, R_L = 4.6 Ω		80	120	
Turn-Off Delay Time	t _{d(off)}	$\rm I_D$ \cong - 2.3 A, $\rm V_{GEN}$ = - 4.5 V, $\rm R_g$ = 1 Ω		20	30	
Fall Time	t _f			12	20	
Turn-On Delay Time	t _{d(on)}			5	10	
Rise Time	t _r	V_{DD} = - 15 V, R_L = 4.6 Ω		13	20	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ - 2.3 A, V_GEN = - 10 V, R_g = 1 Ω		20	30	
Fall Time	t _f			10	15	
Drain-Source Body Diode Characteristic	cs					
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 6.5	A
Pulse Diode Forward Current ^a	I _{SM}				- 19.5	
Body Diode Voltage	V _{SD}	I _S = - 2.3 A		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time	t _{rr}	-		20	30	ns
Body Diode Reverse Recovery Charge	Q _{rr}			20	30	nC
Reverse Recovery Fall Time	t _a	$I_{F} = -2.3 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_{J} = 25 \text{ °C}$		14		1
Reverse Recovery Rise Time	t _b			6		ns

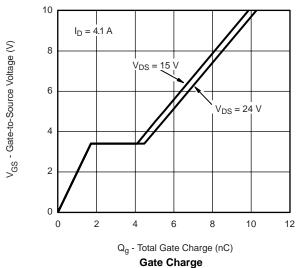
Notes:

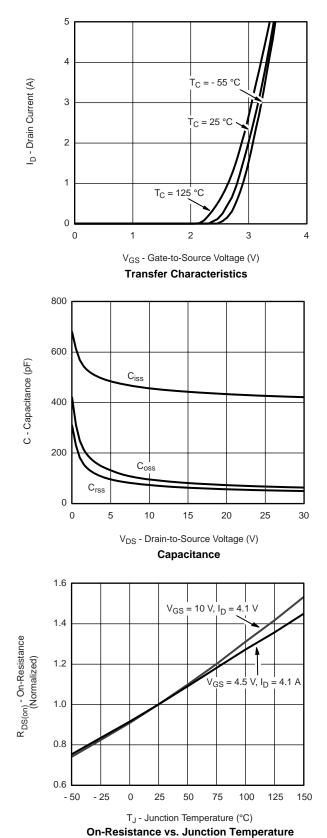
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 % b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



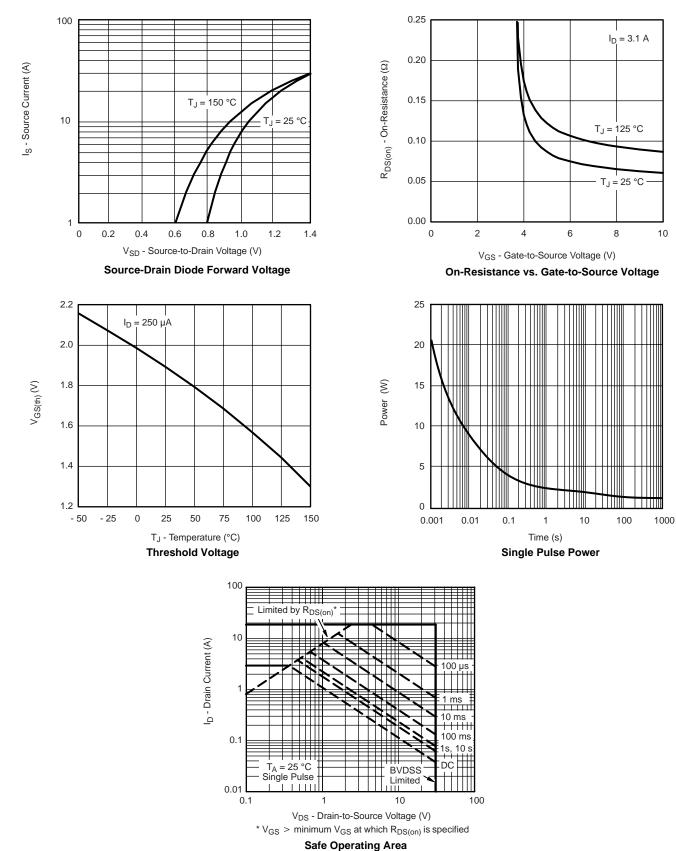






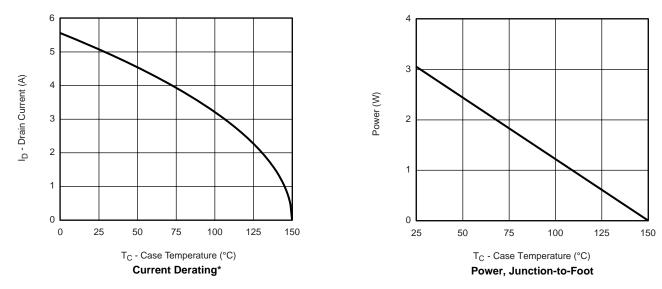
服务热线:400-655-8788





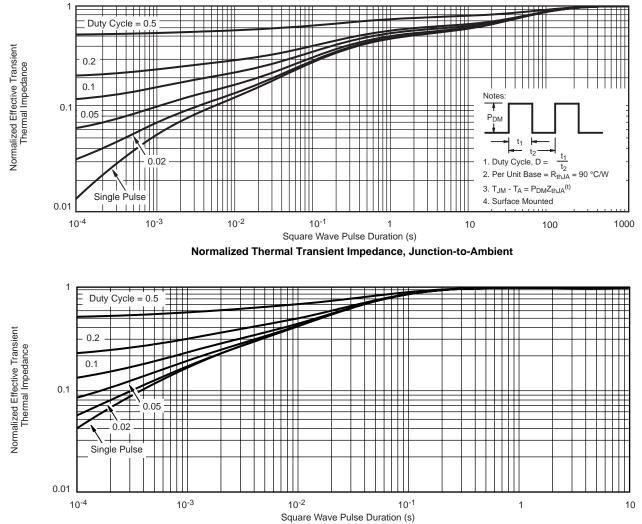






* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



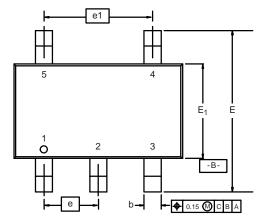


Normalized Thermal Transient Impedance, Junction-to-Foot

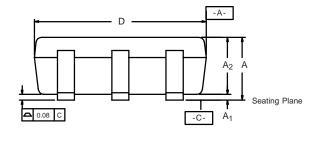
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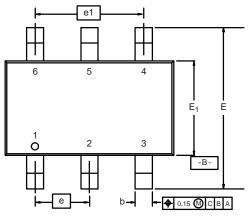


TSOP: 5/6-LEAD JEDEC Part Number: MO-193C

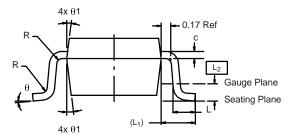








6-LEAD TSOP

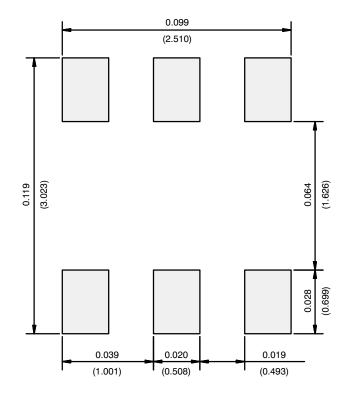


	MIL	LIMETER	RS	I			
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.91	-	1.10	0.036	-	0.043	
A ₁	0.01	-	0.10	0.0004	-	0.004	
A ₂	0.90	-	1.00	0.035	0.038	0.039	
b	0.30	0.32	0.45	0.012	0.013	0.018	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.95	3.05	3.10	0.116	0.120	0.122	
Е	2.70	2.85	2.98	0.106	0.112	0.117	
E ₁	1.55	1.65	1.70	0.061	0.065	0.067	
е	0.95 BSC			0.0374 BSC			
e 1	1.80	1.90	2.00	0.071	0.075	0.079	
L	0.32	-	0.50	0.012	-	0.020	
L ₁	0.60 Ref			0.024 Ref			
L ₂	0.25 BSC			0.010 BSC			
R	0.10	-	-	0.004	-	-	
θ	0°	4°	8°	0°	4°	8°	
θ_1	7° Nom				7° Nom		
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540							

SI3445DV-T1-GE3-VB



RECOMMENDED MINIMUM PADS FOR TSOP-6



Recommended Minimum Pads Dimensions in Inches/(mm)



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